SILICON (Si) POWER MOSFET A CEB840G



CEB840G

500V ▲ 0.65Ω ▲ 8A ▲ Si MOSFET

SILICON Si MOSFET ▲ SMD type N-channel enhancement mode UL94V-0 rated flame retardant epoxy TO263 (D2PAK) package ▲ MSL 3 Super high dense cell density for extremely low R_{DS(ON)} High power and current handling capability





RoHS

REACH

MAXIMUM RATINGS

Parameter (T_c = 25°C, unless otherwise noted)	Characteristics	
Drain-Source Voltage	V _{DS}	500V
Gate-Source Voltage	V _{GS}	±30V
Continuous Drain Current at T _c = 25°C	I _D	8A
Pulsed Drain Current Note 1	IDM Note 5	32A
Maximum Power Dissipation at T _c = 25°C	PD	125W
Power Dissipation Derating above 25°C	ΔP _D	1W/°C
Operating and Storage Temperature Range	T _J , T _{STG}	-55°C to +150°C

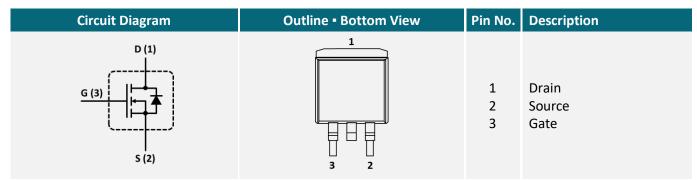
THERMAL CHARACTERISTICS

Parameter	Symbol	Limit
Thermal Resistance, Junction-to-Case	R _{TH_JC}	1°C/W
Thermal Resistance, Junction-to-Ambient	R _{TH_JA}	62.5°C/W

APPLICATIONS

General Lighting	Industrial	Motors	Power	UPS
LED & CCFL	Inverters	& Drives	Supplies	
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PIN DESCRIPTION





ELECTRICAL CHARACTERISTICS A T_c = 25°C, unless otherwise noted

ltem	Condition	Symbol	Min.	Тур.	Max.	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu A$	BV _{DSS}	500			V
Zero Gate Voltage Drain Current	V_{DS} = 500V, V_{GS} = 0V	I _{DSS}			25	μA
Gate Body Leakage Current, Forward	$V_{GS} = 30V, V_{DS} = 0V$	I _{GSSF}			100	nA
Gate Body Leakage Current, Reverse	V_{GS} = -30V, V_{DS} = 0V	I _{GSSR}			-100	nA
On Characteristics Note 2						
Gate Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 250 \mu A$	V _{GS(th)}	2		4	V
Static Drain-Source On-Resistance	$V_{GS} = 10V, I_{D} = 4.8A$	R _{DS(ON)}		0.65	0.85	Ω
Dynamic Characteristics Note 3						
Input Capacitance	$V_{DS} = 25V, V_{GS} = 0V, f = 1MHz$	CISS		1340		рF
Output Capacitance	$V_{DS} = 25V, V_{GS} = 0V, f = 1MHz$	Coss		160		рF
Reverse Transfer Capacitance	V_{DS} = 25V, V_{GS} = 0V, f = 1MHz	C _{RSS}		15		pF
Switching Characteristics Note 3						
Turn-On Delay Time	V_{DD} = 250V, V_{GS} = 10V, I_{D} = 8A, $R_{\text{G}(\text{ext})}$ = 9.1 Ω	t _{D(ON)}		28		ns
Turn-On Rise Time	V_{DD} = 250V, V_{GS} = 10V, I_{D} = 8A, $R_{\text{G}(\text{ext})}$ = 9.1 Ω	t _R		7		ns
Turn-Off Delay Time	V_{DD} = 250V, V_{GS} = 10V, I_{D} = 8A, $R_{\text{G}(\text{ext})}$ = 9.1 Ω	$t_{D(OFF)}$		41		ns
Turn-Off Fall Time	V_{DD} = 250V, V_{GS} = 10V, I_{D} = 8A, $R_{\text{G}(\text{ext})}$ = 9.1 Ω	t _F		5		ns
Total Gate Charge	V_{DS} = 400V, V_{GS} = 10V, I_{D} = 8A	Q_{G}		22		nC
Gate Source Charge	V_{DS} = 400V, V_{GS} = 10V, I_{D} = 8A	Q _{GS}		6		nC
Gate Drain Charge	V_{DS} = 400V, V_{GS} = 10V, I_D = 8A	\mathbf{Q}_{GD}		7		nC
Drain-Source Diode Characteristics a	nd Maximum Ratings					
Drain-Source Diode Forward Current		ls			8	А
Drain-Source Diode Forward Voltage Note 2	V _{GS} = 0V, I _S = 8A	V_{SD}			1.5	V

Notes

- 1: Repetitive Rating: Pulse width limited by maximum junction temperature
- 2: Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 3: Guaranteed by design, not subject to production testing.
- 4: Limited only by maximum temperature allowed.
- 5: Pulse width limited by safe operating area.

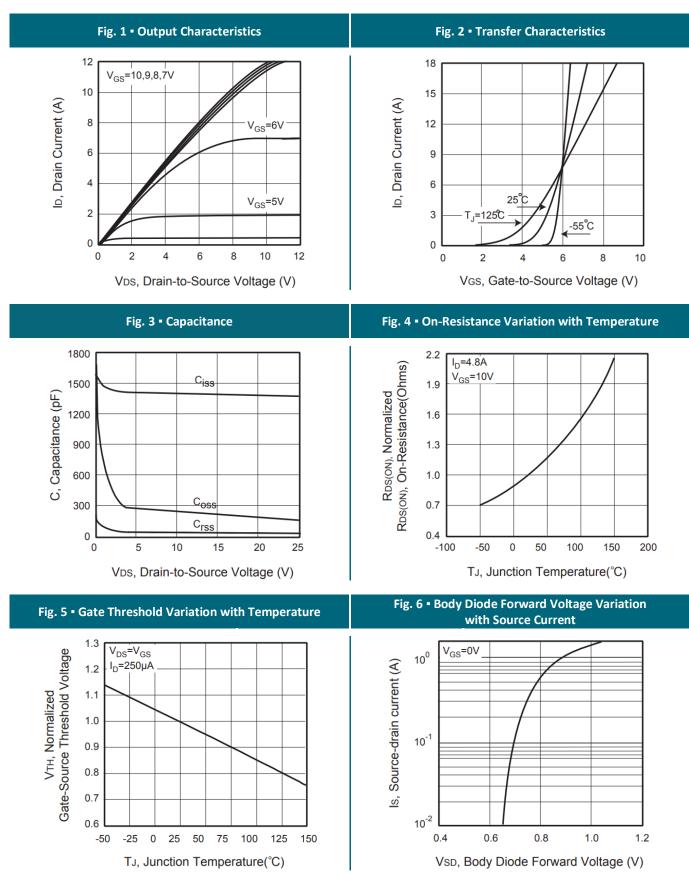
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REFERENCE DATA A TYPICAL DEVICE PERFORMANCE



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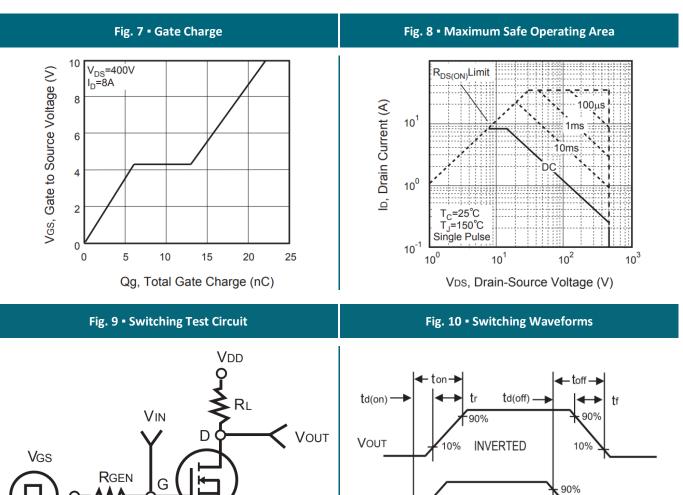
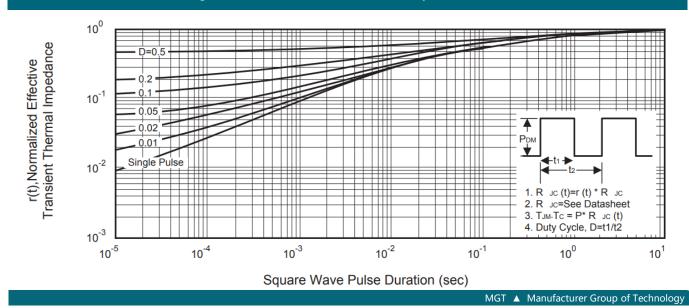


Fig. 11 • Normalized Thermal Transient Impedance Curve

50%

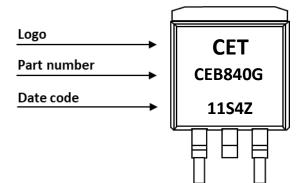
. 50%





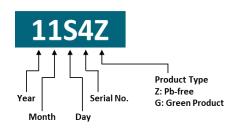






DATE CODE

Example: 11S4Z



Coding list for "Day"

1	2	3	4	5	6	7	8	9	A
01	02	03	04	05	06	07	08	09	10
B	C	D	E	F	G	H	 	J	K
11	12	13	14	15	16	17	18	19	20
L	M	N	0	P	Q	R	S	T	U
21	22	23	24	25	26	27	28	29	30
V 31									

Coding list for "Month"

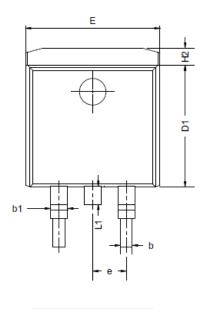
1 Jan		2 eb	3 Mar	4 Apr	5 May	6 Jun				
7 Jul		8 .ug	9 Sep	A Oct	B Nov	C Dec				
	Coding list for "Year"									
	0	1	2		34					
2	020	202	1 20	22 20	023 203	24				
	5	6	7	/ {	39)				
2	025	202	6 20	27 20	28 20	29				

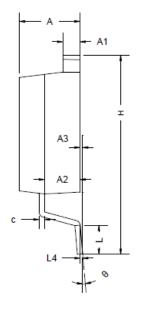
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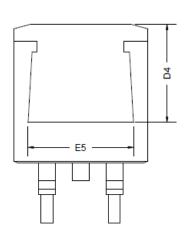




PACKAGE OUTLINE







Sym	Millimeters (Min.)	Millimeters (Typ.)	Millimeters (Max.)	Sym	Millimeters (Min.)	Millimeters (Typ.)	Millimeters (Max.)
А	4.37	4.57	4.77	Е	9.86	10.16	10.36
A1	1.22	1.27	1.42	E5	7.06	-	-
A2	2.49	2.69	2.89	е		2.54 BSC	
A3	0.00	0.13	0.25	н	14.70	15.10	15.50
b	0.70	0.81	0.96	H2	1.07	1.27	1.47
b1	1.17	1.27	1.47	L	2.00	2.30	2.60
С	0.30	0.38	0.53	L1	1.40	1.55	1.70
D1	8.50	8.70	8.90	L4		0.25 BSC	
D4	6.60	-	-	θ	0°	5°	9°

ORDERING INFORMATION

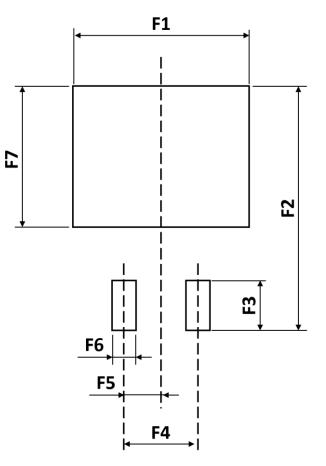
Part Number	Package	Packing	Reel Qty.	Inner Box Qty.	Outer Box Qty.
CEB840G	TO263 (D2PAK)	Reel	800pcs	800pcs	6,400pcs

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RECOMMENDED PAD LAYOUT



Sym	Millimeters (Min.)	Millimeters (Typ.)	Millimeters (Max.)	Sym	Millimeters (Min.)	Millimeters (Typ.)	Millimeters (Max.)
F1	-	12.20	-	F5	-	2.54	-
F2	-	16.90	-	F6	-	1.60	-
F3	-	2.54	-	F7	-	9.75	-
F4	-	5.08	-				

Notes:

1. The suggested land pattern dimensions have been provided for reference only.

2. For further information, please reference document IPC-7351A.

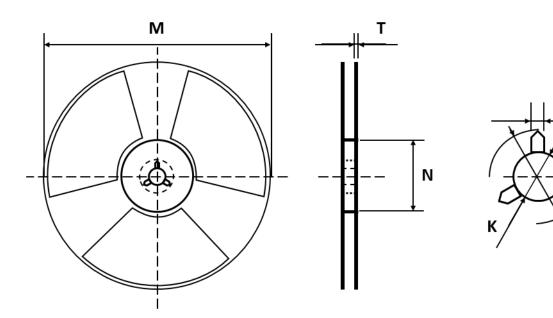


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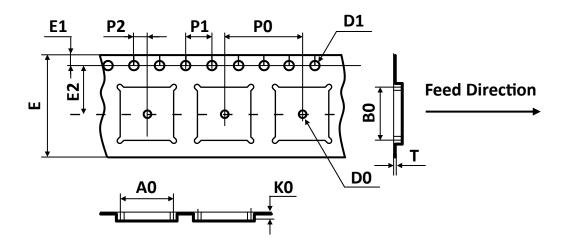


REEL DIMENSIONS All dimensions in mm



Tape Size	Reel Size	М	N	т	Н	К	S
		Ø330.00	Ø100.00	2.10	22.00	13.00	2.00
24mm	Ø330	Ø330 ±2.00	±0.50	±0.20	±0.50	+0.50	+0.50
						-0.20	-0.20

TAPE DIMENSIONS All dimensions in mm



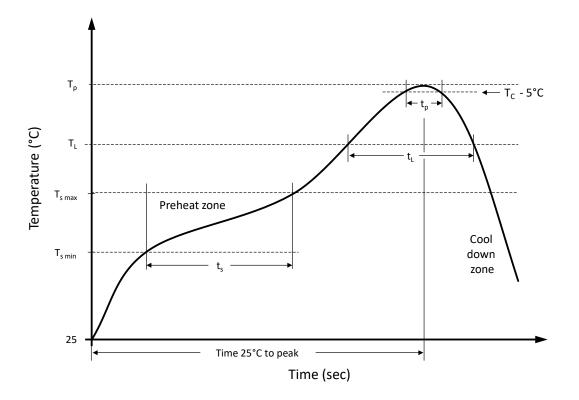
Package	A0	B0	К0	D0	D1	E	E1	E2	P0	P1	P2	Т
TO263	10.80	16.30	4.85	1.50	1.55	24.00	1.75	11.50	16.00	4.00	2.00	0.35
(D ² PAK)	±0.10	±0.10	±0.10	±0.10	±0.05	±0.30	±0.10	±0.10	±0.10	±0.10	±0.10	±0.05







RECOMMENDED REFLOW SOLDERING PROFILE



Recommended reflow soldering conditions ▲ **Refer to JEDEC J-STD-020E**

Profile Features		Sn-Pb Eutetic Assembly	Pb-Free Assembly
Preheat temperature min.	T_{smin}	100 °C	150 °C
Preheat temperature max.	T_{smax}	150 °C	200 °C
Preheat time t_s from $T_{s min}$ to $T_{s max}$	ts	120 seconds	120 seconds
Ramp-up rate (T _L to T _p)		max. 3 °C/second	max. 3 °C/second
Liquidous temperature	ΤL	183 °C	217 °C
Time t_L maintained above T_L	tL	150 seconds max.	150 seconds max.
Peak package body temperature	Tp	235°C	260°C
Timeframe of within 5°C below and up to max actual peak body temperature	tp	20 seconds max.	30 seconds max.
Ramp-down rate (T_L to T_p)		max. 6 °C/second	max. 6 °C/second
Time 25°C to peak temperature		max. 6 minutes	max. 8 minutes



REVISION TABLE

Revision	Date	Status	Notes
001	30/09/2022	Initial release	Initial publication

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